



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : David M. Buczak et al. Art Unit : 2827
 Serial No. : 09/658,838 Examiner : Kamand Cuneo
 Filed : September 8, 2000
 Title : POLYMER ENCAPSULATED CERAMIC SUPERCONDUCTORS

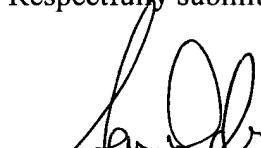
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INFORMATION DISCLOSURE STATEMENT

Applicant submits the references listed on the attached form PTO-1449.

This filing is being made with the filing of a Request for Continued Examination. No fee is required.

Respectfully submitted,

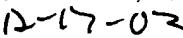

 Sean P. Daley
 Reg. No. 40,978

Fish & Richardson P.C.
 225 Franklin Street
 Boston, MA 02110-2804
 Telephone: (617) 542-5070
 Facsimile: (617) 542-8906

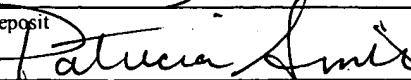
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Substitute Form PTO-1449 (Modem)	U.S. Department of Commerce Patent and Trademark Office	Attorney's Docket No. 05770-138001	Application No. 09/658,838
Information Disclosure Statement by Applicant (Use several sheets if necessary)		DEC 22 2003 Applicant David M. Buczak et al.	
(37 CFR §1.13(d)) TRADEMA		Filing Date September 8, 2000	Group Art Unit 2827

U.S. Patent Documents							
Examiner Initial	Desig. ID	Document Number	Publication Date	Patentee	Class	Subclass	Filing Date If Appropriate
	AA	4,970,483	11/1990	Wicker et al.			
	AB	4,973,574	11/1990	Nishio et al.			
	AC	4,975,416	12/1990	Onishi et al.			
	AD	4,994,435	2/1991	Shiga et al.			
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	AV	6,110,606	08/2000	Scudiere et al.			

Foreign Patent Documents or Published Foreign Patent Applications							
Examiner Initial	Desig. ID	Document Number	Publication Date	Country or Patent Office	Class	Subclass	Translation <input checked="" type="checkbox"/> Yes <input type="checkbox"/> No
	AW	6 309 955-A	11/1994	Japan			X
	AX	WO99/19707	04/1999	PCT International			

Examiner Signature	Date Considered
EXAMINER: Initials citation considered. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.	

Substitute Form PTO-1449 Modified Information Disclosure Statement by Applicant DEC. 22 2003 (Use several sheets if necessary) (37 CFR §1.65(b))	U.S. Department of Commerce Patent and Trademark Office	Attorney's Docket No. 05770-138001	Application No. 09/658,838
		Applicant David M. Buczak et al.	
		Filing Date September 8, 2000	Group Art Unit 2827

Foreign Patent Documents or Published Foreign Patent Applications							
Examiner Initial	Desig. ID	Document Number	Publication Date	Country or Patent Office	Class	Subclass	Translation <input checked="" type="checkbox"/> Yes <input type="checkbox"/> No
	AY	EP 0837512	04/1998	Europe			
	AZ	01153507 A (abstract only)	06/1989	Japan			
	AAA	06 162 835	06/1994	Japan			
	ABB	02 050 403	02/1990	Japan			

Other Documents (include Author, Title, Date, and Place of Publication)		
Examiner Initial	Desig. ID	Document
*	ACC	

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